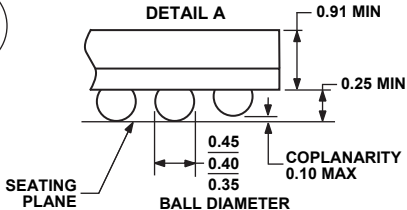
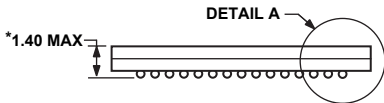
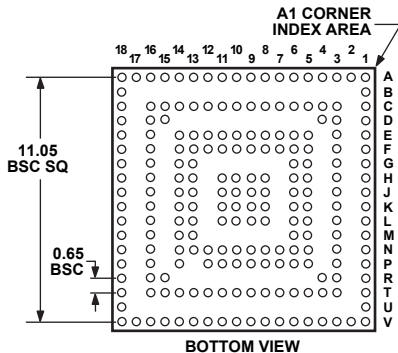
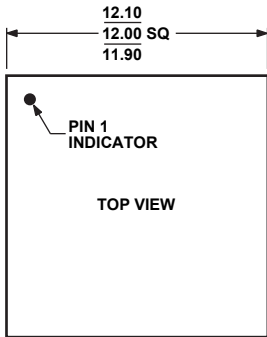


**204-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-204)**

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-225
WITH THE EXCEPTION TO PACKAGE HEIGHT.